# **IR Receiver Modules for Remote Control Systems**



- Very low supply current
- · Photo detector and preamplifier in one package
- · Compatible also with short burst dataformats
- Supply voltage: 2.5 V to 5.5 V
- Improved immunity against ambient light
- · Capable of side or top view
- Two lenses for high sensitivity and wide receiving angle
- Insensitive to supply voltage ripple and noise
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### DESCRIPTION

The TSOP753..., TSOP755.. series are a two lens miniaturized receiver module for infrared remote control systems. One PIN diode per lens and a preamplifier are assembled on a leadframe, the epoxy lens cap contains an IR filter.

The TSOP753..series is optimized to suppress almost all spurious pulses from energy saving lamps like CFLs. AGC3 may also suppress some data signals if continuously transmitted.

The TSOP755.. series contain a very robust AGC5. This series should only be used for critically noisy environments. This component has not been qualified according to automotive specifications

automoti	automotive specifications.	
IOISY ENVIRONMENTS D SHORT BURSTS (AGC3)	VERY NOISY ENVIRONMENTS AND SHORT BURSTS (AGC5)	
TSOP75330	TSOP75530	

AGC		NOISY ENVIRONMENTS AND SHORT BURSTS (AGC3)	VERY NOISY ENVIRONMENTS AND SHORT BURSTS (AGC5)
	30 kHz	TSOP75330	TSOP75530
	33 kHz	TSOP75333	TSOP75533
Carrier	36 kHz	TSOP75336 <sup>(1)</sup>	TSOP75536
frequency	38 kHz	TSOP75338 <sup>(2)(3)(4)(5)</sup>	TSOP75538
	40 kHz	TSOP75340	TSOP75540
	56 kHz	TSOP75356	TSOP75556
Package		Heir	ndall
Pinning		1, 4 = GND, 2	= V <sub>S</sub> , 3 = OUT
Dimensions	s (mm)	6.8 W x 3.	0 H x 3.2 D
Mounting		SI	MD
Application		Remote	e control
Best choice	e for	<sup>(1)</sup> MCIR <sup>(2)</sup> Mitsubishi <sup>(3)</sup> RECS-80	OCode <sup>(4)</sup> r-map <sup>(5)</sup> XMP-1, XMP-2

20953

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### **MECHANICAL DATA**

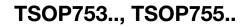
**Pinning:** 1, 4 = GND, 2 =  $V_S$ , 3 = OUT

## **ORDERING CODE**

PARTS TABLE

Taping: TSOP75...TT - top view taped TSOP75...TR - side view taped

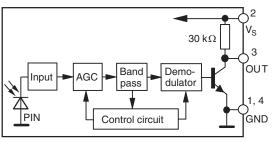




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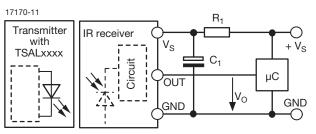
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## **BLOCK DIAGRAM**



20445-1

#### **APPLICATION CIRCUIT**



 $R_1$  and  $C_1$  recommended to reduce supply ripple for  $V_S < 2.8$  V

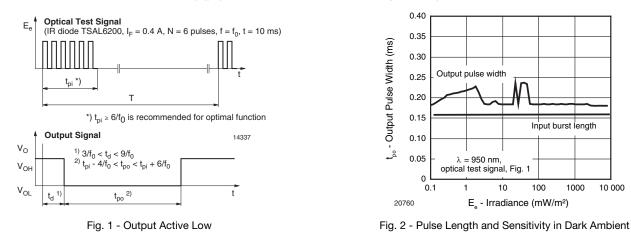
ABSOLUTE MAXIMUM RAT	BSOLUTE MAXIMUM RATINGS			
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage		V <sub>S</sub>	-0.3 to +6	V
Supply current		ا <sub>S</sub>	3	mA
Output voltage		Vo	-0.3 to (V <sub>S</sub> + 0.3)	V
Output current		I <sub>O</sub>	5	mA
Junction temperature		Тj	100	°C
Storage temperature range		T <sub>stg</sub>	-25 to +85	°C
Operating temperature range		T <sub>amb</sub>	-25 to +85	°C
Power consumption	T <sub>amb</sub> ≤ 85 °C	P <sub>tot</sub>	10	mW

Note

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability

ELECTRICAL AND O	<b>L AND OPTICAL CHARACTERISTICS</b> ( $T_{amb} = 25 \text{ °C}$ , unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage		Vs	2.5	-	5.5	V
Supply current	$E_v = 0, V_S = 3.3 V$	I <sub>SD</sub>	0.27	0.35	0.45	mA
Supply current	E <sub>v</sub> = 40 klx, sunlight	I <sub>SH</sub>	-	0.45	-	mA
Transmission distance	$E_v = 0$ , test signal see Fig. 1, IR diode TSAL6200, I <sub>F</sub> = 200 mA	d	-	45	-	m
Output voltage low	$I_{OSL} = 0.5 \text{ mA}, E_e = 0.7 \text{ mW/m}^2$ , test signal see Fig. 1	V <sub>OSL</sub>	-	-	100	mV
Minimum irradiance	Pulse width tolerance: $t_{pi}$ - 5/f <sub>o</sub> < $t_{po}$ < $t_{pi}$ + 6/f <sub>o</sub> , test signal see Fig. 1	E <sub>e min.</sub>	-	0.12	0.25	mW/m <sup>2</sup>
Maximum irradiance	$t_{pi}$ - 5/f <sub>o</sub> < $t_{po}$ < $t_{pi}$ + 6/f <sub>o</sub> , test signal see Fig. 1	E <sub>e max.</sub>	30	-	-	W/m <sup>2</sup>
Directivity	Angle of half transmission distance	φ1/2	-	± 50	-	deg

#### TYPICAL CHARACTERISTICS (T<sub>amb</sub> = 25 °C, unless otherwise specified)

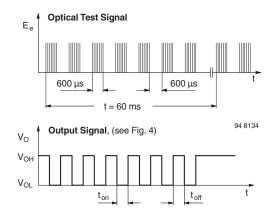


Rev. 1.6, 14-Sep-17

Document Number: 82495

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#### Fig. 3 - Output Function

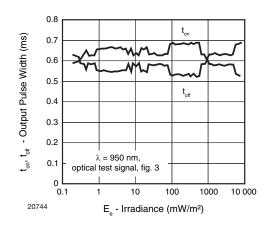


Fig. 4 - Output Pulse Diagram

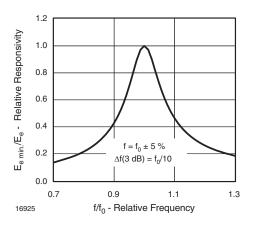


Fig. 5 - Frequency Dependence of Responsivity

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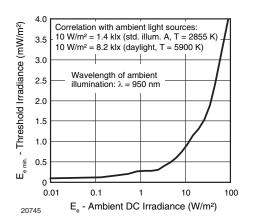


Fig. 6 - Sensitivity in Bright Ambient

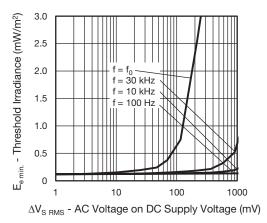


Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

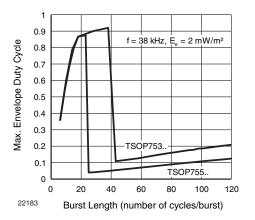


Fig. 8 - Max. Envelope Duty Cycle vs. Burst Length

Rev. 1.6, 14-Sep-17



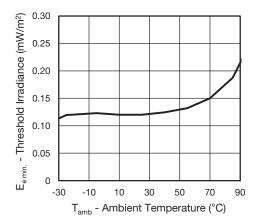


Fig. 9 - Sensitivity vs. Ambient Temperature

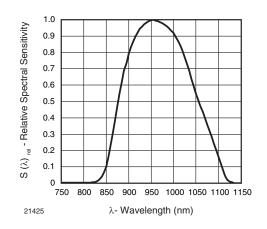


Fig. 10 - Relative Spectral Sensitivity vs. Wavelength

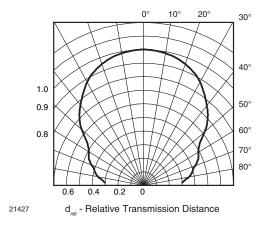


Fig. 11 - Horizontal Directivity

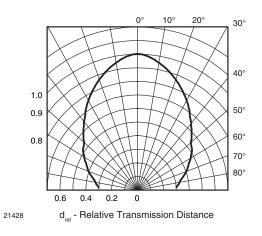


Fig. 12 - Vertical Directivity

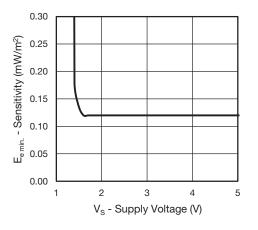


Fig. 13 - Sensitivity vs. Supply Voltage

Rev. 1.6, 14-Sep-17



## SUITABLE DATA FORMAT

The TSOP753.., TSOP755.. series are designed to suppress spurious output pulses due to noise or disturbance signals. Data and disturbance signals can be distinguished by the devices according to carrier frequency, burst length and envelope duty cycle. The data signal should be close to the band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal is applied to the TSOP753.. and TSOP755.. in the presence of a disturbance signal, the sensitivity of the receiver is reduced to insure that no spurious pulses are present at the output. Some examples of disturbance signals which are suppressed are:

- DC light (e.g. from tungsten bulb or sunlight)
- · Continuous signals at any frequency
- Strongly or weakly modulated pattern from fluorescent lamps with electronic ballasts (see Fig. 14 or Fig. 15)

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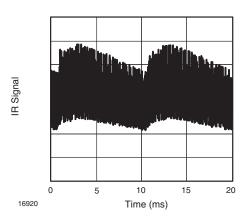


Fig. 14 - IR Disturbance from Fluorescent Lamp with Low Modulation

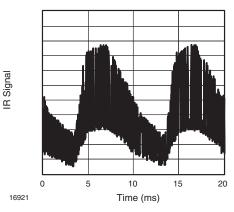


Fig. 15 - IR Disturbance from Fluorescent Lamp with High Modulation

	TSOP753	TSOP755
Minimum burst length	6 cycles/burst	6 cycles/burst
After each burst of length a minimum gap time is required of	6 to 35 cycles ≥ 10 cycles	6 to 24 cycles ≥ 10 cycles
For bursts greater than a minimum gap time in the data stream is needed of	35 cycles > 4 x burst length	24 cycles > 25 ms
Maximum number of continuous short bursts/second	2000	2000
MCIR code	Preferred	Yes
RCMM code	Preferred	Yes
XMP-1, XMP-2 code	Preferred	Yes
Suppression of interference from fluorescent lamps	Mild and complex disturbance patterns are suppressed (example: signal pattern of Fig. 14 and Fig. 15)	Critical disturbance patterns are suppressed, e.g. highly dimmed LCDs

#### Note

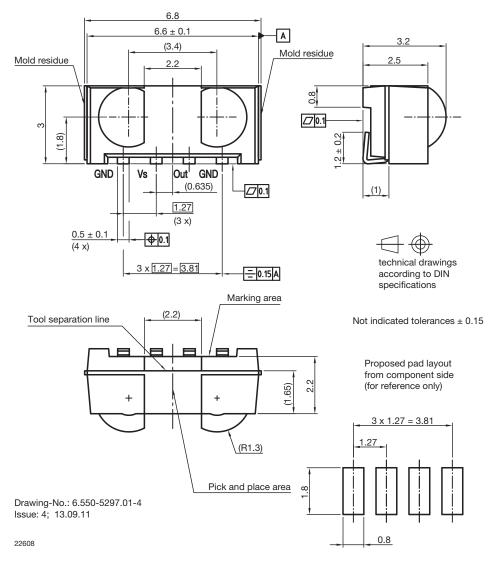
• For data formats with long bursts please see the datasheet for TSOP752.., TSOP754..



## TSOP753.., TSOP755..

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## **PACKAGE DIMENSIONS** in millimeters



## **ASSEMBLY INSTRUCTIONS**

#### **Reflow Soldering**

- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

#### Manual Soldering

- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off

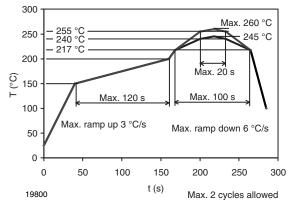
Rev. 1.6, 14-Sep-17



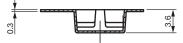
# TSOP753.., TSOP755..

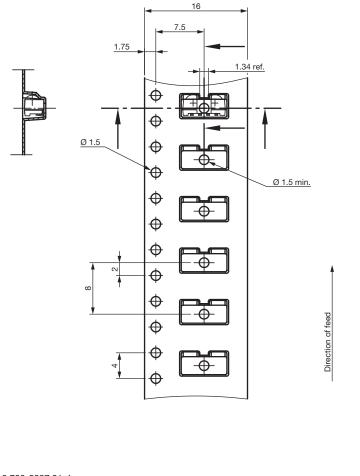
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## VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE



## TAPING VERSION TSOP..TR DIMENSIONS in millimeters





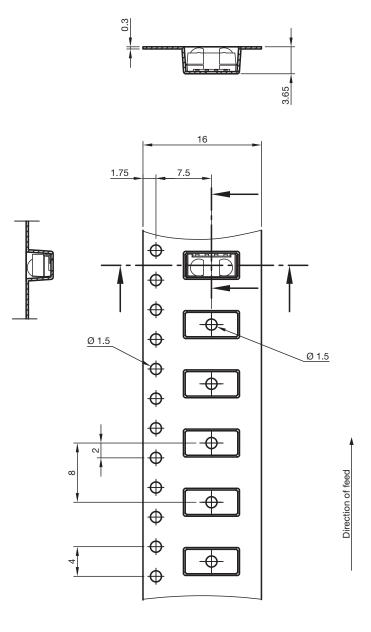
Drawing-No.: 9.700-5337.01-4 Issue: 2; 06.10.15



Rev. 1.6, 14-Sep-17



## TAPING VERSION TSOP..TT DIMENSIONS in millimeters



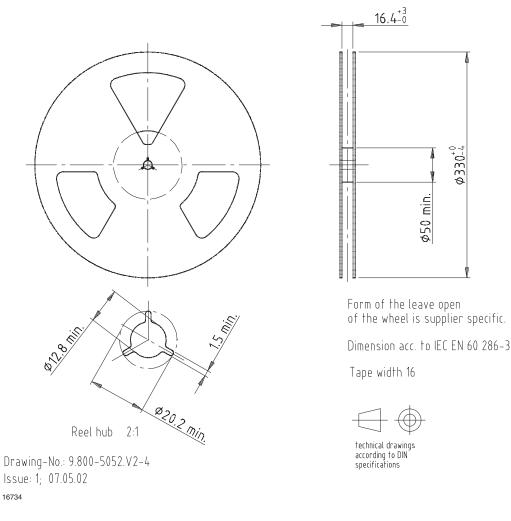


technical drawings according to DIN specifications

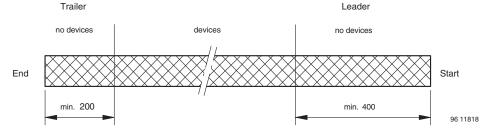
Drawing-No.: 9.700-5338.01-4 Issue: 4; 12.06.13



## **REEL DIMENSIONS** in millimeters



#### LEADER AND TRAILER DIMENSIONS in millimeters



## **COVER TAPE PEEL STRENGTH**

According to DIN EN 60286-3 0.1 N to 1.3 N 300 ± 10 mm/min. 165° to 180° peel angle

## LABEL

#### Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

# TSOP753.., TSOP755..

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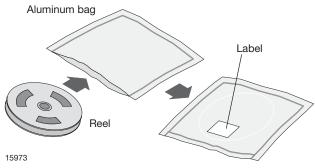
Rev. 1.6, 14-Sep-17



VISHAY SEMICONDUCTOR Gr	nbH STANDARD BAR CODE PRO	DUCT LABEL (finished goods)
PLAIN WRITING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	XXXXXXX+	Company logo
LONG BAR CODE TOP	ТҮРЕ	LENGTH
Item-number	N	8
Plant-code	N	2
Sequence-number	Х	3
Quantity	N	8
Total length	-	21
SHORT BAR CODE BOTTOM	ТҮРЕ	LENGTH
Selection-code	Х	3
Data-code	N	3
Batch-number	Х	10
Filter	-	1
Total length	-	17

## **DRY PACKING**

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



### **FINAL PACKING**

The sealed reel is packed into a cardboard box.

## **RECOMMENDED METHOD OF STORAGE**

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity  $\leq$  60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60  $^{\circ}\text{C}$  + 5  $^{\circ}\text{C}$  and < 5 % RH for all device containers or

24 h at 125  $^\circ\text{C}$  + 5  $^\circ\text{C}$  not suitable for reel or tubes.

An EIA JEDEC<sup>®</sup> standard J-STD-020 level 4 label is included on all dry bags.



EIA JEDEC standard J-STD-020 level 4 label is included on all dry bags

Rev. 1.6, 14-Sep-17



## ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

### VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.

#### BAR CODE PRODUCT LABEL (example)



22178



# **Tape and Reel Standards for Surface-Mount IR Receiver Modules**

Vishay Semiconductor surface-mount IR receivers are packaged on tape and reel. The following specification is based on IEC publication 286, which takes the industrial requirements for automatic insertion into account.

Absolute maximum ratings, mechanical dimensions, optical and electrical characteristics for taped devices are identical to the basic catalog types and can be found in the specifications for untaped devices.

## PACKAGING

The tapes of components are available on reels. Each reel is marked with labels which contain the following information:

- Vishay
- Туре
- Group
- Tape code, normally part of type name
- Production code
- Quantity

## **MISSING COMPONENTS**

Up to 3 consecutive components may be missing if the gap is followed by at least 6 components. A maximum of 0.5 % of the components per reel quantity may be missing. At least 5 empty positions are present at the start and the end of the tape to enable tape insertion.

**Tensile strength** of the tape: > 15 N

## NUMBER OF COMPONENTS

- A. Panhead: quantity per reel:
  TT, top view package, 1190 pcs
  TR, side view package, 1120 pcs
- B. Heimdall: quantity per reel:
  TT, top view package, 2200 pcs
  TR, side view package, 2300 pcs
- C. Heimdall without lens: quantity per reel: WTT, top view package, 2200 pcs WTR, side view package, 2300 pcs
- D. Belobog: quantity per reel:
  TT1, top view package, 1800 pcs
  TT2, top view package, 7000 pcs
- E. Belobog with shield: quantity per reel: TT1, top view package, 1500 pcs TT2, top view package, 5000 pcs
- F. Minimold DF1P: quantity per reel: DF1P, 1100 pcs
- G. TVCastSMD TR1: quantity per reel: TR1, side view package, 2000 pcs

## **ORDER DESIGNATION**

The type designation of the device is extended by TT or TT1 for top view or TR for side view.

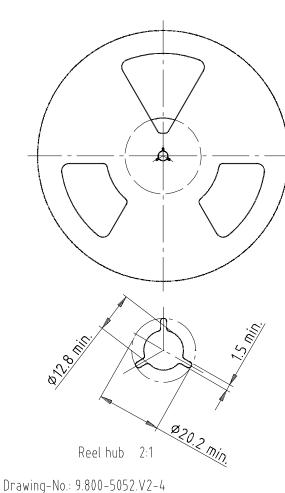
## Example:

TSOP6238TR (reel packing)

- TSOP75238TR (reel packing)
- TSOP75338WTT (reel packing)
- TSOP57438TT1 (reel packing)
- TSOP57238HTT1 (reel packing)
- TSOP39438TR1 (reel packing)



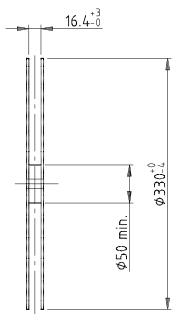
## REEL DIMENSIONS FOR PANHEAD, HEIMDALL, AND TVCASTSMD TR in millimeters



Issue: 1; 07.05.02

#### Note

• The body structure of the reel can vary



Form of the leave open of the wheel is supplier specific.

Dimension acc. to IEC EN 60 286-3

Tape width 16



technical drawings according to DIN specifications

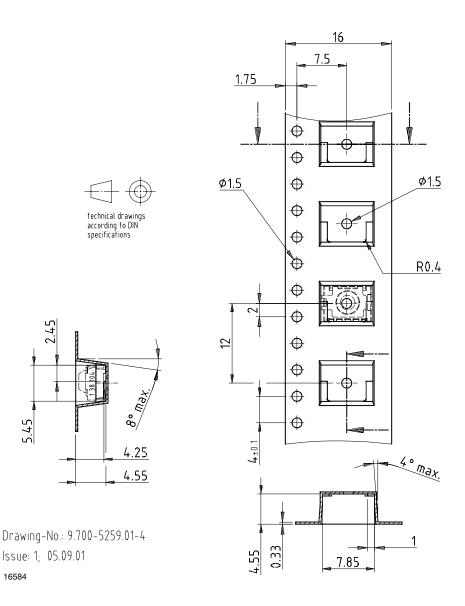
Rev. 2.4, 17-Aug-17

2



## TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

A. Panhead (TSOP36...TT, TSSP....TT, TSOP6...TT, TSOP16...TT, TSOP96...TT)

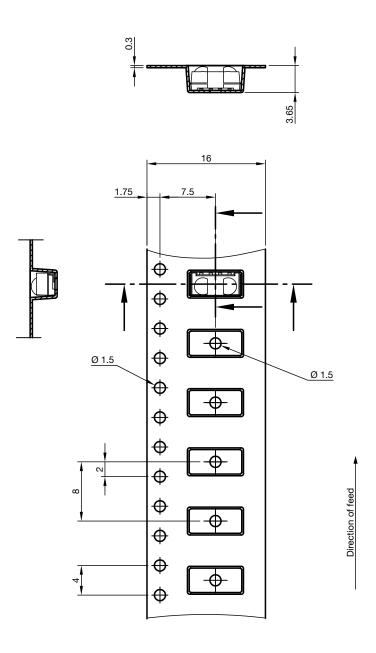


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## TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

B. Heimdall (TSOP75...TT, TSOP77...TT, TSSP77...TT, TSOP15...TT, TSOP95...TT)





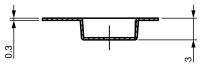
technical drawings according to DIN specifications

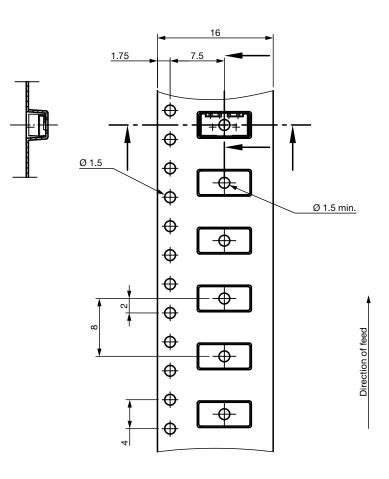
Drawing-No.: 9.700-5338.01-4 Issue: 4; 12.06.13



## TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

C. Heimdall without lens (TSOP75...WTT, TSOP77...WTT, TSSP77...WTT, TSOP15...WTT, TSOP95...WTT)







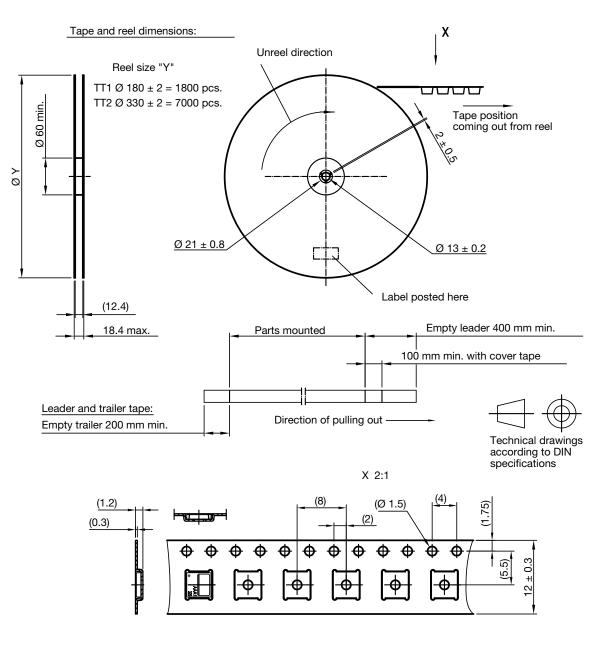
technical drawings according to DIN specifications

Drawing-No.: 9.700-5341.01-4 Issue: 3; 06.10.15



## TAPING VERSION TSOP..TT1, TSOP..TT2 (TOP VIEW) DIMENSIONS in millimeters

D. Belobog (TSOP37...TT1, TSOP37...TT2, TSOP57...TT1, TSOP57...TT2, TSOP17...TT1, TSOP17...TT2, TSOP97...TT1, TSOP97...TT2)

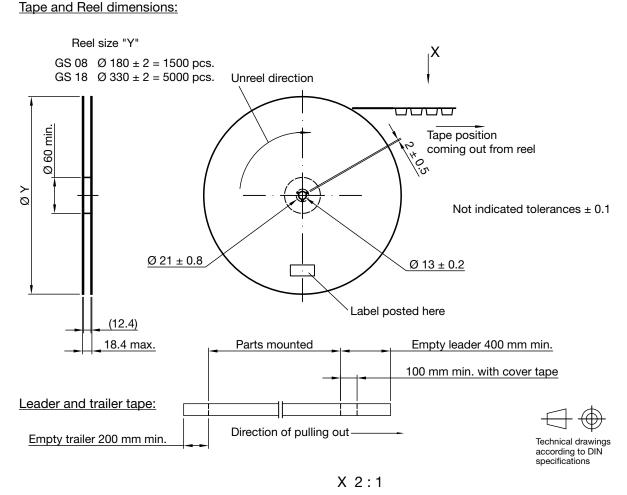


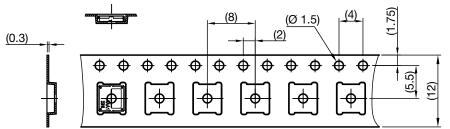
Drawing-No.: 9.700-5347.01-4 Issue: 1; 14.11.11 Not indicated tolerances  $\pm 0.1$ 



## TAPING VERSION TSOP..TT1, TSOP..TT2 (TOP VIEW) DIMENSIONS in millimeters

E. Belobog with shield (TSOP37...HTT1, TSOP37...HTT2, TSOP57...HTT1, TSOP57...HTT2, TSOP17...HTT1, TSOP17...HTT1, TSOP97...HTT2)





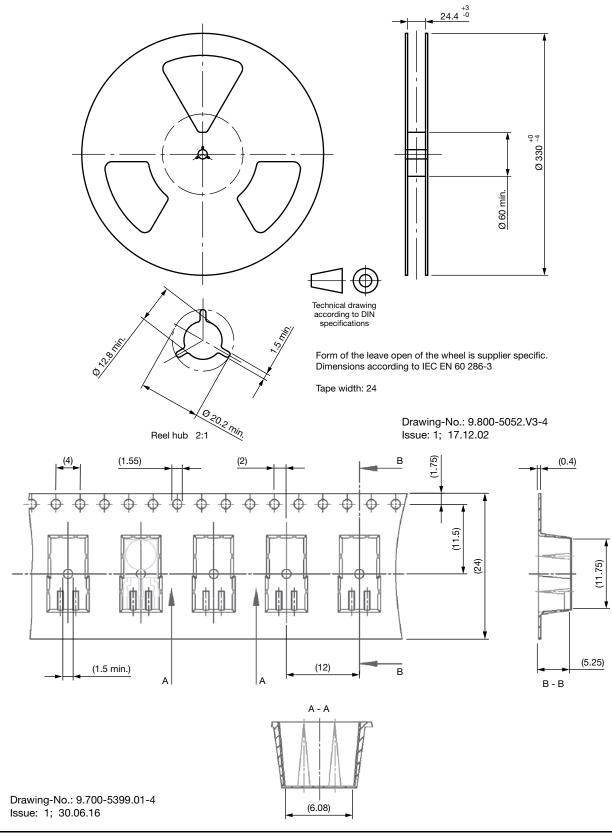
Reel dimensions and tape

Drawing-No.: 9.700-5380.01-4 Issue: 1; 28.10.13 WISHAY www.vishay.com

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## TAPING VERSION TSOP...DF1P (SIDE VIEW) DIMENSIONS in millimeters

F. Minimold DF1P (TSOP33...DF1P, TSOP53...DF1P, TSOP13...DF1P, TSOP93...DF1P)



Rev. 2.4, 17-Aug-17

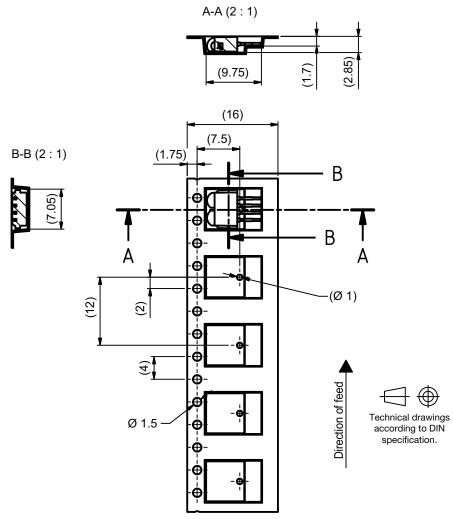
8

Document Number: 80125



## TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

G. TVCastSMD TR1 (TSOP59...TR1, TSOP39...TR1, TSOP19...TR1, TSOP99...TR1)

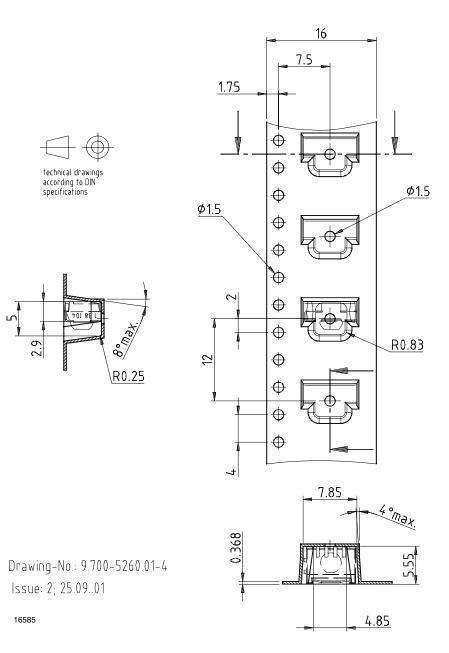


Drawing-No.: GO-100220.10\_Z Issue B: 08.02.17

## TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

A. Panhead (TSOP36...TR, TSSP6...TR, TSOP6...TR, TSOP16...TR, TSOP96...TR)

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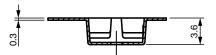


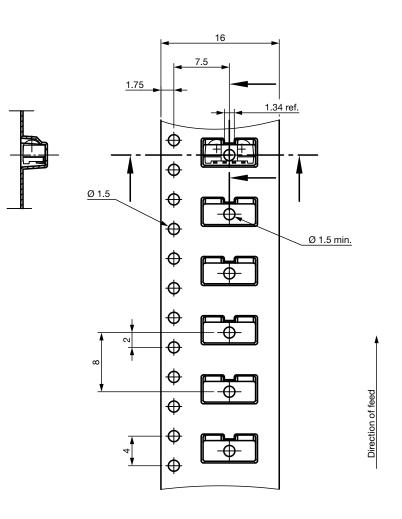
VISHAY



## TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

B. Heimdall (TSSP7...., TSOP75...TR, TSOP77...TR, TSSP7....TR, TSOP15...TR, TSOP95...TR)







technical drawings according to DIN specifications

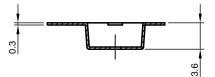
Drawing-No.: 9.700-5337.01-4 Issue: 2; 06.10.15

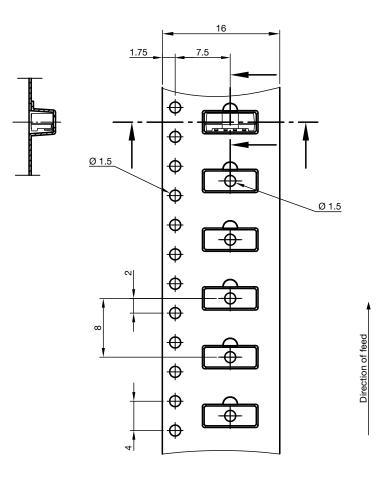
11



## TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

C. Heimdall without lens (TSOP75...WTR, TSOP77...WTR, TSSP...WTR, TSOP15...WTR, TSOP95...WTR)







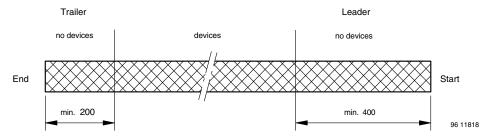
technical drawings according to DIN specifications

Drawing-No.: 9.700-5342.01-4 Issue: 2; 12.06.13





#### LEADER AND TRAILER DIMENSIONS in millimeters



## **COVER TAPE REEL STRENGTH**

According to DIN EN 60286-3 0.1 N to 1.3 N 300 mm/min.  $\pm$  10 mm/min. 165° to 180° peel angle

#### LABEL

#### Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

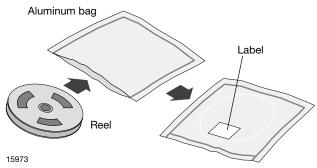
PLAIN WRITING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	XXXXXXX+	Company logo
LONG BAR CODE TOP	ТҮРЕ	LENGTH
Item-number	Ν	8
Plant-code	Ν	2
Sequence-number	Х	3
Quantity	Ν	8
Total length	-	21
SHORT BAR CODE TOP	ТҮРЕ	LENGTH
Selection-code	Х	3
Data-code	Ν	3
Batch-number	Х	10
Filter	-	1
Total length	-	17

Rev. 2.4, 17-Aug-17



## DRY PACKAGING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



### **RECOMMENDED METHOD OF STORAGE**

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity  $\leq$  60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60  $^\circ\text{C}$  + 5  $^\circ\text{C}$  and < 5 % RH for all device containers or

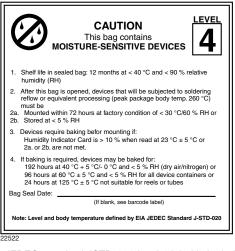
24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC<sup>®</sup> standard JSTD-020 level 4 label is included on all dry bags.

## **OUTER PACKAGING**

The sealed reel is packed into a pizza box.

## **Vishay Semiconductors**



EIA JEDEC standard JSTD-020 level 4 label is included on all dry bags

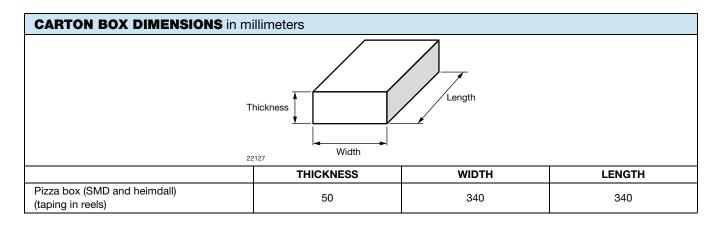
## ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

### VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.





Rev. 2.4, 17-Aug-17

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Vishay

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